

PCN Number: 21038 Date Issued: 8/30/3021 Product(s) Affected:			Means of Distinguishing Changed Devices: Product Mark:
SP348	35CN-L	SP3485EN-L	Back Mark
SP3485	CN-L/TR	SP3485EN-L/TR	Date Code
Manufacturing Location Affected:Key FoundryDate Effective (90 day window):August 30, 2021Date Issued +90 days:November 30, 2021			
Contact:			Attachment: 🗌 Yes 🔀 No
Your local MaxLinear Marketing Representative or contact our Customer Support team by creating a Support Ticket at http://www.maxlinear.com/support/createcase Phone: 1-760-692-0711			eam by Samples: Request from MaxLinear Marketing Representatives
Description and Purpose of Change: MaxLinear has qualified Key Foundry wafer foundry in order to increase production capacity and to facilitate long term support of the product line. The wafer process is 0.18um BCD. The process has been optimized to produce very similar product characteristics as the currently shipping devices from TSMC foundry and will meet existing datasheet specifications. Die Technology Wafer Fabrication Material Material Material Material Material Material Material Diata SheetProduct Desing Wanufacturing Site mor required to ensure full design functionality per datasheet. Adjustments at ICT testing may be required to prevent false failures. Die Technology			
Reliability/Qualification Summary: Reliability reports available upon request			
Customer Acknowledgement of Receipt within 30 days of issue. Lack of acknowledgement within 30 days constitutes acceptance of change.			
Please fax or email this form to the contact above after completing the following information: Customer: Date:			
Name:		E-Mail:	
Title:			
Phone:		_	
Fax:			
Approval for shipments prior to effective date			
Customer Comments (Optional):			